Working Implementation Agreements for Open Systems Interconnection Protocols: Part 16 - Open Document Architecture Level 3 Profile

Output from the December 1993 Open Systems Environment Implementors' Workshop (OIW)

SIG Chair: **Jon Stewart, Quality One Softworks**
SIG Editor: **Jim Wing, IBM Software Solutions**

Foreword

This part of the Working Implementation Agreements was prepared by the Multimedia Data and Document Interchange Special Interest Group (MDDISIG) of the Open Systems Environment Implementors' Workshop (OIW). See Part 1 - Workshop Policies and Procedures in the "Draft Working Implementation Agreements Document" for the workshop charter.

The MDDISIG has worked as an authorized agent of the Plenary to produce the final text for publication of ISP 11182-1 (FOD36). This text has been moved to the Stable Implementation Agreements which will contain a reference to the published ISP only.

Future changes and additions to this version of these Implementor Agreements will be published as a new part, for example, see Part 27.

Table of Contents

Part 16 - Open Document Architecture Level 3 Profile 1

1 Open Document Architecture Level 3 DAP 1

2 Open Document Architecture Level 3 ISR 1

3 Open Document Architecture Level 3 ATS 1

Part 16 - Open Document Architecture Level 3 Profile

1 Open Document Architecture Level 3 DAP

The Document Application Profile (DAP) document for the Level 3 Profile has been approved as ISP 11182-1 : 1993.

NOTE - Please refer to the Stable Implementation Agreements for information on this Part.

2 Open Document Architecture Level 3 ISR

The Implementation Support Requirements (ISR) document for the Level 3 Profile is in development. See Part 27. The technical editor is Jim Wing, IBM, of OIW.

3 Open Document Architecture Level 3 ATS

The Abstract Test Suite (ATS) for the Level 3 Profile is in development. The technical editor is Makota Oya, Hitachi, of AOW. The results of this work are available in the documents to be provided by INTAP.